



Interference Suppression Film Capacitor - Class X2 Radial MKT 310 V_{AC} - High Stability Grade



FEATURES

- AEC-Q200 qualified (rev. D) up to 110 °C for \leq 470 nF
- Compliant with IEC 60381-14: AMD1 grade IB
 THB: 85 °C / 85 % RH, 168 h at U_{RAC}
- THB: 40 °C / 90 % RH for 1000 h at rated voltage, in compliance with AEC-Q200
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





ROHS

APPLICATIONS

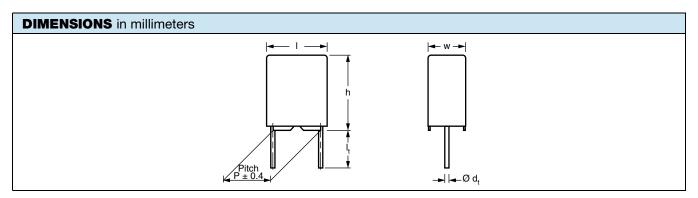
High stability grade for continuous across the line X2 applications.

See also application note: www.vishay.com/doc?28153

QUICK REFERENCE DATA	
Capacitance range (E12 series)	0.01 μF to 2.2 μF (preferred values acc. to E6)
Capacitance tolerance	± 10 %, ± 20 % (± 5 % on request)
Rated AC voltage	310 V _{AC} ; 50 Hz to 60 Hz
Permissible DC voltage	800 V _{DC} at 85 °C 630 V _{DC} at 110 °C
Climatic testing class according to IEC 60068-1	40/110/56/C
Maximum application temperature	110 °C
Reference standards	IEC 60384-14 ed-4 and EN 60384-14 IEC 60065 pass. flamm. class C CSA-E384-14 UL 60384-14
Dielectric	Polyester film
Electrodes	Metallized
Construction	Series construction
Encapsulation	Plastic case, epoxy resin sealed, flame retardant UL-class 94 V-0
Leads	Tinned wire
Marking	C-value; tolerance; rated voltage; sub-class; manufacturer's type; code for dielectric material; manufacturer location, year and week; manufacturer's logo or name; safety approvals

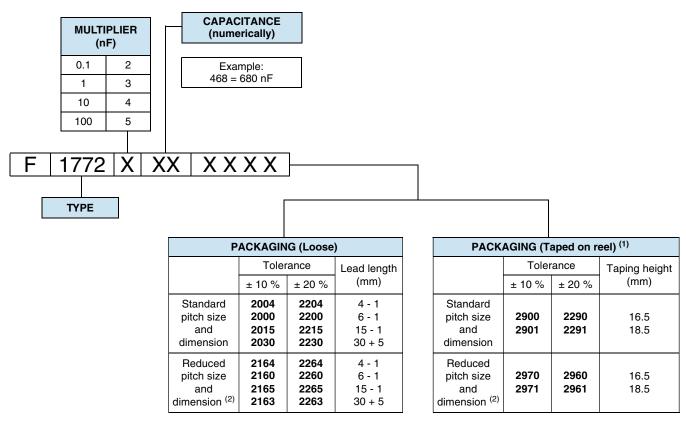
Note

• For more detailed data and test requirements, contact rfi@vishay.com





COMPOSITION OF CATALOG NUMBER



Example: F1772415**2215** means 0.15 μ F, \pm 20 %; standard pitch 22.5 mm; lead length 15 mm - 1 mm; F1772415**2265** means 0.15 μ F, \pm 20 %; reduced pitch 15.0 mm; lead length 15 mm - 1 mm

Notes

- For detailed tape specifications refer to packaging information <u>www.vishay.com/doc?28139</u>
- (1) Taped on reel pitch ≥ 27.5 mm is not available
- (2) Same capacitance values ≥ 0.15 µF are available in two different pitch sizes and dimensions

SPECIFIC REFERENCE DATA				
DESCRIPTION	VALUE			
Rated AC voltage (U _{RAC})	310 V			
Permissible DC voltage (U _{RDC})	630 V			
Tangent of loss angle	≤ 100 x 10 ⁻⁴ at 1 kHz			
Rated voltage pulse slope at (dU/dt) _R 435 V _{DC}	100 V/μs			
R between leads, for C ≤ 0.33 µF at 100 V; 1 min	$>$ 15 000 M Ω			
RC between leads, C > 0.33 µF at 100 V; 1 min	> 5000 s			
R between leads and case; 100 V; 1 min	$>$ 30 000 M Ω			
Withstanding (DC) voltage (cut off current 10 mA) (1); rise time ≤ 1000 V/s				
C ≤ 0.47 µF	2200 V; for 1 min			
$C > 0.47 \mu F$	2150 V; for 1 min			
Withstanding (AC) voltage between leads and case	2120 V; 1 min			
Maximum application temperature	110 °C			

Note

• See "Voltage Proof Test for Metalized Film Capacitors": www.vishay.com/doc?28169



			DIMENSIONS (4)		SPQ	ORDERING CODE	
U _{RAC} (V)	CAP. (μF)	PITCH (mm)	w x h x l MAX. (mm)	MASS ⁽³⁾ (g)	(pieces) SHORT LEAD	BULK LEAD LENGTH 6 mm - 1 mm ⁽¹⁾⁽²⁾	
	d _t = 0.60 mm ± 0.06 mm; C-TOL. = ± 10 %						
	0.010	15	5.0 x 11.0 x 17.5	1.4	750	F17723102000	
	0.012	15	5.0 x 11.0 x 17.5	1.4	750	F17723122000	
	0.015	15	5.0 x 11.0 x 17.5	1.4	750	F17723152000	
	0.018	15	5.0 x 11.0 x 17.5	1.4	750	F17723182000	
	0.022	15	5.0 x 11.0 x 17.5	1.4	750	F17723222000	
	0.027	15	5.0 x 11.0 x 17.5	1.4	750	F17723272000	
	0.033	15	5.0 x 11.0 x 17.5	1.4	750	F17723332000	
	0.039	15	6.0 x 12.0 x 17.5	2.0	500	F17723392000	
	0.047	15	6.0 x 12.0 x 17.5	2.0	500	F17723472000	
	0.056	15	6.0 x 12.0 x 17.5	2.0	500	F17723562000	
			d _t = 0.80 mm ± 0.08 mi	n; C-TOL. = ± 10 9	%		
	0.068	15	7.0 x 13.5 x 17.5	2.4	450	F17723682000	
	0.082	15	8.5 x 15.0 x 17.5	2.7	300	F17723822000	
	0.10	15	8.5 x 15.0 x 17.5	2.7	325	F17724102000	
	0.12	15	8.5 x 15.0 x 17.5	2.7	300	F17724122000	
	0.15	15	8.5 x 15.0 x 17.5	2.7	300	F17724152160	
	0.15	22.5	7.0 x 16.5 x 26.0	4.1	235	F17724152000	
	0.18	22.5	7.0 x 16.5 x 26.0	4.1	235	F17724182000	
	0.22	15	10.0 x 16.5 x 17.5	3.0	235	F17724222160	
	0.22	22.5	8.5 x 16.5 x 26.5	4.6	200	F17724222000	
	0.27	22.5	10.0 x 19.5 x 26.0	6.7	170	F17724272000	
	0.33	15	13.5 x 22.5 x 18.0	5.5	185	F17724332160	
310	0.33	22.5	10.0 x 19.5 x 26.0	6.7	170	F17724332000	
	0.39	27.5	11.0 x 21.0 x 31.0	9.1	125	F17724392000	
	0.47	22.5	12.0 x 22.0 x 26.0	13.0	110	F17724472160	
	0.47	27.5	11.0 x 21.0 x 31.0	9.1	125	F17724472000	
	0.56	27.5	11.0 x 21.0 x 31.0	9.1	125	F17724562000	
	0.68	22.5	15.5 x 26.5 x 26.5	13.5	110	F17724682160	
	0.68	27.5	13.0 x 23.0 x 31.0	12.9	110	F17724682000	
	0.82	27.5	13.0 x 23.0 x 31.0	12.9	110	F17724822000	
	1.0	22.5	15.5 x 26.5 x 26.5	13.5	110	F17725102160	
	1.0	27.5	15.0 x 25.0 x 31.5	15.0	100	F17725102000	
	1.2	37.5	14.5 x 24.5 x 41.5	18.9	80	F17725122000	
	1.5	27.5	18.0 x 28.0 x 31.0	19.0	85	F17725152160	
	1.5	37.5	15.5 x 28.5 x 41.5	24.0	70	F17725152000	
	1.8	37.5	15.5 x 28.5 x 41.5	24.0	70	F17725182000	
	2.2	27.5	21.0 x 31.0 x 31.0	28.0	70	F17725222160	
	2.2	37.5	18.0 x 32.5 x 41.5	31.6	60	F17725222000	
			d _t = 0.60 mm ± 0.06 mi	m; C-TOL. = ± 20 °	%		
	0.010	15	5.0 x 11.0 x 17.5	1.4	750	F17723102200	
	0.015	15	5.0 x 11.0 x 17.5	1.4	750	F17723152200	
	0.022	15	5.0 x 11.0 x 17.5	1.4	750	F17723222200	
	0.033	15	5.0 x 11.0 x 17.5	1.4	750	F17723332200	
	0.047	15	5.0 x 11.0 x 17.5	1.4	750	F17723472200	
	0.068	15	6.0 x 12.0 x 17.5	2.0	600	F17723682200	
	0.10	15	6.0 x 12.0 x 17.5	2.0	600	F17724102200	



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ELECTI	ELECTRICAL DATA AND ORDERING INFORMATION						
U _{RAC} (V)	CAP. (μF)	PITCH (mm)	DIMENSIONS ⁽⁴⁾ w x h x l MAX. (mm)	MASS ⁽³⁾ (g)	SPQ (pieces) SHORT LEAD	ORDERING CODE BULK LEAD LENGTH 6 mm - 1 mm (1)(2)	
			d _t = 0.80 mm ± 0.08 m	nm; C-TOL. = ± 20 %	ı		
	0.15	15	8.5 x 15.0 x 17.5	2.7	325	F17724152260	
	0.15	22.5	6.0 x 15.5 x 26.0	3.3	260	F17724152200	
	0.22	15	10.0 x 16.5 x 17.5	4.5	300	F17724222260	
	0.22	22.5	7.0 x 16.5 x 26.0	4.1	235	F17724222200	
	0.33	15	13.5 x 22.5 x 18.0	5.5	185	F17724332260	
	0.33	22.5	8.5 x 18.0 x 26.0	5.3	190	F17724332200	
	0.47	22.5	10.0 x 19.5 x 26.0	6.7	170	F17724472260	
310	0.47	27.5	9.0 x 19.0 x 31.5	6.8	160	F17724472200	
	0.68	22.5	12.0 x 22.0 x 26.0	13.4	110	F17724682260	
	0.68	27.5	11.0 x 21.0 x 31.0	12.9	125	F17724682200	
	1.0	22.5	15.5 x 26.5 x 26.5	13.5	110	F17725102260	
	1.0	27.5	15.0 x 25.0 x 31.5	15.0	100	F17725102200	
	1.5	27.5	18.0 x 28.0 x 31.5	19.0	85	F17725152260	
	1.5	37.5	14.5 x 24.5 x 41.5	18.9	80	F17725152200	
	2.2	27.5	21.0 x 31.0 x 31.0	28.0	70	F17725222260	
	2.2	37.5	15.5 x 28.5 x 41.5	24.0	70	F17725222200	

Notes

- SPQ = Standard Packing Quantity
- For detailed tape specifications refer to packaging information: www.vishav.com/doc?28139
- (1) For further packaging see table "Composition of Catalog Number"
- (2) Further information about packaging quantities with different lead length and / or taped versions, see document "Packing Quantities" www.vishay.com/doc?27608
- (3) Weight for short lead product only
- (4) For tolerances see chapter "Space Requirements for Printed-Circuit Board Applications and Dimension Tolerances"

APPROVALS					
SAFETY APPROVALS X2	VOLTAGE	VALUE	FILE NUMBERS	LINK	
EN 60384-14 (ENEC) (= IEC 60384-14 ed-4)	310 V _{AC}	0.01 μF to 2.2 μF X2	40005079	www.vishay.com/doc?28196	
UL 60384-14	310 V _{AC}	0.01 μF to 2.2 μF X2	E354331	www.vishay.com/doc?28191	
CSA-E 384-14	310 V _{AC}	0.01 μF to 2.2 μF X2	E354331	www.visinay.com/doc?26191	
CB test-certificate	310 V _{AC}	0.01 μF to 2.2 μF X2	DE1-58410	www.vishay.com/doc?28226	

The ENEC-approval together with the CB-certificate replace all national marks of the following countries (they have already signed the ENEC-agreement): Austria; Belgium; Czech. Republic; Denmark; Finland; France; Germany; Greece; Hungary; Ireland; Italy; Luxembourg; Netherlands; Norway; Portugal; Slovenian; Spain; Sweden; Switzerland and United Kingdom.





MOUNTING

Normal Use

The capacitors are designed for mounting on printed-circuit boards. The capacitors packed in bandoliers are designed for mounting in printed-circuit boards by means of automatic insertion machines.

For detailed tape specifications refer to packaging information: www.vishay.com/doc?28139.

Specific Method of Mounting to Withstand Vibration and Shock

In order to withstand vibration and shock tests, it must be ensured that stand-off pips are in good contact with the printed-circuit board:

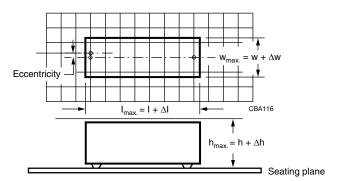
- For pitches ≤ 15 mm capacitors shall be mechanically fixed by the leads
- For larger pitches the capacitors shall be mounted in the same way and the body clamped

SPACE REQUIREMENTS FOR PRINTED-CIRCUIT BOARD APPLICATIONS AND DIMENSION **TOLERANCES**

For the maximum product dimensions and maximum space requirements for length (I_{max.}), width (w_{max.}) and height (h_{max.}) following tolerances must be taken in account in the envelopment of the components as shown in the drawings below.

- For products with pitch \leq 15 mm, $\Delta w = \Delta l = 0.3$ mm, and $\Delta h = 0.1$ mm
- For products with 15 mm < pitch \leq 27.5 mm, $\Delta w = \Delta l = 0.5$ mm, and $\Delta h = 0.1$ mm
- For products with pitch = 37.5 mm, $\Delta w = \Delta l = 0.7$ mm, and $\Delta h = 0.5$ mm

Eccentricity defined as in drawing. The maximum eccentricity is smaller than or equal to the lead diameter of the product concerned.



For the minimum product dimensions for length (I_{min.}), width (w_{min.}) and height (h_{min.}) following tolerances of the components are valid:

 $I_{min.} = I - \Delta I$, $w_{min.} = w - \Delta w$, and $h_{min.} = h - \Delta h$ following

- For products with pitch ≤ 10 mm, $\Delta l = 0.3$ mm, and $\Delta w = \Delta h = 0.3$ mm
- For products with pitch = 15 mm, $\Delta I = 0.5$ mm, and $\Delta w = \Delta h = 0.5$ mm
- For products with 15 mm < pitch \leq 27.5 mm, $\Delta l = 1.0$ mm and $\Delta w = \Delta h = 0.5$ mm
- For products with pitch = 37.5 mm, $\Delta I = 1.0$ mm and $\Delta w = \Delta h = 1.0$ mm

SOLDERING CONDITIONS

For general soldering conditions and wave soldering profile, we refer to the application note: "Soldering Guidelines for Film Capacitors": www.vishay.com/doc?28171

Storage Temperature

 T_{stg} = -25 °C to +35 °C with RH maximum 75 % without condensation

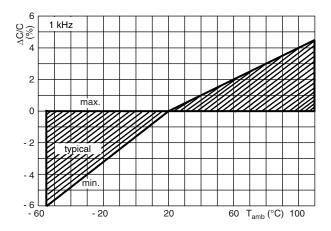
Ratings and Characteristics Reference Conditions

Unless otherwise specified, all electrical values apply to an ambient temperature of 23 °C ± 1 °C, an atmospheric pressure of 86 kPa to 106 kPa and a relative humidity of 50 % \pm 2 %.

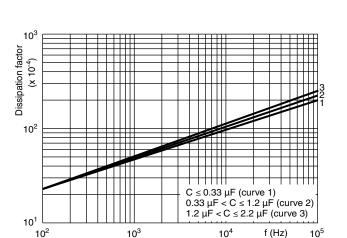
For reference testing, a conditioning period shall be applied over 96 h ± 4 h by heating the products in a circulating air oven at the rated temperature and a relative humidity not exceeding 20 %.



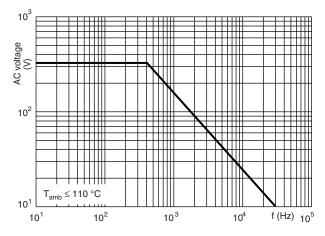
CHARACTERISTICS



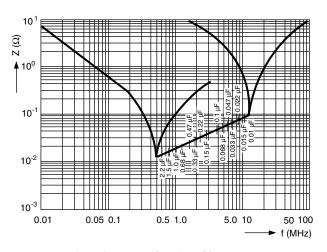
Capacitance as a function of ambient temperature (typical curve)



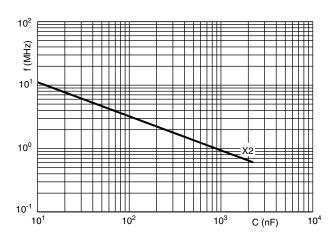
Tangent of loss angle as a function of frequency (typical curve)



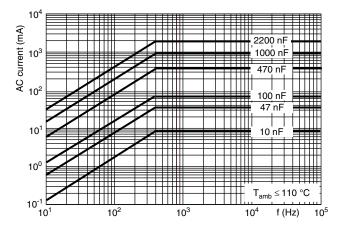
Max. RMS voltage as a function of frequency



Impedance as a function of frequency (typical curve)

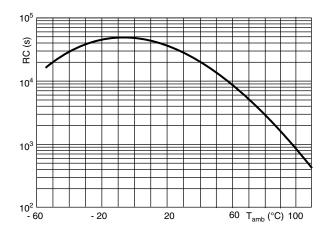


Resonant frequency as a function of capacitance (typical curve)



Max. RMS current as a function of frequency





Insulation resistance as a function of ambient temperature (typical curve)

APPLICATION NOTES AND LIMITING CONDITIONS

- For X2 electromagnetic interference suppression where a higher stability grade is needed for continuous across the line applications (50 Hz/60 Hz) with a maximum mains voltage of 310 V_{AC}.
- These capacitors are not intended for continuous pulse application. For these situations capacitors of the AC and pulse programs must be used.
- For series impedance applications we refer to application note: www.vishay.com/doc?28153
- The maximum ambient temperature must not exceed 110 °C.
- Rated voltage pulse slope:
 if the pulse voltage is lower than the rated voltage, the values of the specific reference data can be multiplied by 435 V_{DC} and divided by the applied voltage.

INSPECTION REQUIREMENTS

General Notes

Sub-clause numbers of tests and performance requirements refer to the "Sectional Specification, Publication IEC 60384-14 ed 3 and Specific Reference Data".

GROUP C INSPECTION REQUIREMENTS				
SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS		
SUB-GROUP C1A PART OF SAMPLE OF SUB-GROUP C1				
4.1 Dimensions (detail)		As specified in chapter "General Data" of this specification		
Initial measurements	Capacitance Tangent of loss angle: for $C \le 1 \mu F$ at 10 kHz for $C > 1 \mu F$ at 1 kHz			
4.3 Robustness of terminations	Tensile: load 10 N; 10 s Bending: load 5 N; 4 x 90°	No visible damage		
4.4 Resistance to soldering heat	No pre-drying Method: 1A Solder bath: 280 °C ± 5 °C Duration: 10 s			



SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-GROUP C1A PART OF SAMPLE OF SUB-GROUP C1		
4.19 Component solvent resistance	Isopropylalcohol at room temperature Method: 2 Immersion time: 5 min ± 0.5 min Recovery time: min. 1 h, max. 2 h	
4.4.2 Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 5$ % of the value measured initiall
	Tangent of loss angle	Increase of tan δ ≤ 0.008 for: $C \leq 1 \mu F$ or ≤ 0.005 for: $C > 1 \mu F$ Compared to values measured initially
	Insulation resistance	As specified in section "Insulation Resistance" of this specification
SUB-GROUP C1B PART OF SAMPLE OF SUB-GROUP C1		
Initial measurements	Capacitance Tangent of loss angle: for C ≤ 1 µF at 10 kHz for C > 1 µF at 1 kHz	
4.20 Solvent resistance of the marking	Isopropylalcohol at room temperature Method: 1 Rubbing material: cotton wool Immersion time: 5 min ± 0.5 min	No visible damage Legible marking
4.6 Rapid change of temperature	θA = -40 °C θB = +110 °C 5 cycles Duration t = 30 min	
4.6.1 Inspection	Visual examination	No visible damage
4.7 Vibration	Mounting: see section "Mounting" of this specification Procedure B4 Frequency range: 10 Hz to 55 Hz Amplitude: 0.75 mm or Acceleration 98 m/s² (whichever is less severe) Total duration 6 h	
4.7.2 Final inspection	Visual examination	No visible damage
4.9 Shock	Mounting: See section "Mounting" for more information Pulse shape: half sine Acceleration: 490 m/s² Duration of pulse: 11 ms	
4.9.2 Final measurements	Visual examination	No visible damage
	Capacitance	$ \Delta C/C \le 5$ % of the value measured initally
	Tangent of loss angle	Increase of $\tan \delta$ ≤ 0.008 for: $C \leq 1$ μF or ≤ 0.005 for: $C > 1$ μF Compared to values measured initially
	Insulation resistance	As specified in section "Specific Reference of this specification



SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-GROUP C1 COMBINED SAMPLE OF SPECIMENS OF SUB-GROUPS C1A AND C1B	CONDITIONS	TEIN ONWARDE NEGOTIEMENTO
4.11 Climatic sequence	Capacitance	
4.11.1 Initial measurements	Measured in 4.4.2 and 4.9.2 Tangent of loss angle Measured initally in C1A and C1B	
4.11.2 Dry heat	Temperature: 110 °C Duration: 16 h	
4.11.3 Damp heat cyclic Test Db, first cycle		
4.11.4 Cold	Temperature: -40 °C Duration: 2 h	
4.11.5 Damp heat cyclic Test Db, remaining cycles		
4.11.6 Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 5$ % of the value measured in 4.11.1
	Tangent of loss angle	Increase of $\tan \delta$ ≤ 0.008 for: $C \leq 1~\mu F$ or ≤ 0.005 for: $C > 1~\mu F$ Compared to values measured in 4.11.1
	Voltage proof 1350 V _{DC} 1 min between terminations	No permanent breakdown or flash-over
	Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification
SUB-GROUP C2		
4.12 Damp heat steady state	56 days, 40 °C, 90 % to 95 % RH No load	
4.12.1 Initial measurements	Capacitance Tangent of loss angle: 1 kHz	
4.12.3 Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 5$ % of the value measured in 4.12.1
	Tangent of loss angle	Increase of tan δ \leq 0.008 for: C \leq 1 μ F or \leq 0.005 for: C $>$ 1 μ F Compared to values measured in 4.12.1
	Voltage proof 1350 V _{DC} ; 1 min between terminations	No permanent breakdown or flash-over
	Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification



SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-GROUP C2A		
4.12A Damp heat steady state with load	RH: 85 %; temp.: 85 °C, load: 310 V _{AC} Duration: 168 h	
4.12.1A Initial measurements	Capacitance Tangent of loss angle: 1 kHz	
4.12.3A Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 10$ % of the value measured in 4.12.1
	Tangent of loss angle	Increase of $\tan \delta$ ≤ 0.024 for: $C \leq 1~\mu F$ or ≤ 0.015 for: $C > 1~\mu F$ Compared to values measured in 4.12.1
	Insulation resistance	\geq 50 % of values specified in section "Insulation Resistance" of this specification or minimum 200 M Ω , whichever is higher
SUB-GROUP C3		
4.13.1 Initial measurements	Capacitance Tangent of loss angle: for C ≤ 1 μF at 10 kHz for C > 1 μF at 1 kHz	
4.13 Impulse voltage	3 successive impulses, full wave, peak voltage: X2: 2.5 kV for C ≤ 1 μF X2: 2.5 kV/√C for C > 1 μF Max. 24 pulses	No self healing breakdowns or flash-over
4.14 Endurance	Duration: 1000 h 1.25 x U_{RAC} at 110 °C Once in every hour the voltage is increased to 1000 V (RMS) for 0.1 s via resistor of 47 Ω ± 5 %	
4.14.7 Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 5$ % compared to values measured in 4.13.1
	Tangent of loss angle	Increase of $\tan \delta$ ≤ 0.008 for: $C \leq 1 \ \mu F$ or ≤ 0.005 for: $C > 1 \ \mu F$ Compared to values measured in 4.13.1
	Voltage proof 1350 V _{DC} ; 1 min between terminations 2120 V _{AC} ; 1 min between terminations and case	No permanent breakdown or flash-over
	Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification



SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-GROUP C4	CONDITIONS	T EM CHIMATOE REGULEMENTS
4.15 Charge and discharge	10 000 cycles Charged to 435 V _{DC} Discharge resistance:	
	$R = \frac{435 \text{ V}_{DC}}{1.5 \text{ x C}(\text{dU/dt})}$	
4.15.1 Initial measurements	Capacitance Tangent of loss angle: for $C \le 1 \mu F$ at 10 kHz for $C > 1 \mu F$ at 1 kHz	
4.13.3 Final measurements	Capacitance	$ \Delta C/C \le 10$ % compared to values measured in 4.15.1
	Tangent of loss angle	Increase of tan δ \leq 0.008 for: C \leq 1 μ F or \leq 0.005 for: C $>$ 1 μ F Compared to values measured in 4.15.1
	Insulation resistance	≥ 50 % of values specified in section "Insulation Resistance" of this specification
SUB-GROUP C5		
4.16 Radio frequency characteristic	Resonance frequency	≥ 0.9 times the value as specified in section "Resonant Frequency" of this specification.
SUB-GROUP C6		
4.17 Passive flammability Class C	Bore of gas jet: Ø 0.5 mm Fuel: butane Test duration for actual volume V in mm³: $V \le 250$: 5 s $250 < V \le 500$: 10 s $500 < V \le 1750$: 20 s V > 1750: 30 s	After removing test flame from capacitor, the capacitor must not continue to burn for more than 30 s. No burning particle must drop from the sample.
	One flame application	
SUB-GROUP C7		
4.18 Active flammability	20 cycles of 2.5 kV discharges on the test capacitor connected to U _{RAC} .	The cheese cloth around the capacitors sha not burn with a flame. No electrical measurements are required.



TES	TEST CONDITIONS AND REQUIREMENTS ACCORDING AEC-Q200 REVISION D					
NO.	TEST NAME	REFERENCE	TEST CONDITIONS	PERFORMANCE REQUIREMENTS		
1	Pre- and post-stress electrical test	Spec.	-	-		
3	High temperature exposure (storage)	MIL-STD 202 method 108	110 °C; unpowered 250 h / 500 h / 1000 h	$\begin{split} & \Delta C/C \leq 5~\%\\ & \text{Increase of tan }\delta\\ &\leq 0.008~\text{for }C \leq 1~\mu\text{F at }10~\text{kHz or}\\ &\leq 0.005~\text{for }C > 1~\mu\text{F at }1~\text{kHz}\\ & R>50~\%~\text{of initial specified value} \end{split}$		
4	Temperature cycling	JESD22 method JA-104	1000 cycles: -40 °C / +110 °C 30 min. dwell time at each temperature extreme Transition time < 1 min.	$ \Delta C/C $ ≤ 5 % Increase of tan δ ≤ 0.008 for C ≤ 1 μF at 10 kHz or ≤ 0.005 for C > 1 μF at 1 kHz IR > 50 % of initial specified value		
6	Moisture resistance	MIL-STD 202 method 106	10 cycles at 24 h/cycle unpowered	$ \Delta C/C \le 5$ % Increase of tan δ ≤ 0.008 for C ≤ 1 μF at 10 kHz or ≤ 0.005 for C > 1 μF at 1 kHz IR > 50 % of initial specified value		
7	Biased humidity	MIL-STD 202 method 103	40 °C; 93 % RH; U _{RAC} (310 V _{AC}) 250 h / 500 h / 1000 h	$\begin{split} & \Delta C/C \leq 10~\%\\ & \text{Increase of tan }\delta\\ &\leq 0.008~\text{for }C \leq 1~\mu\text{F at }10~\text{kHz or}\\ &\leq 0.005~\text{for }C > 1~\mu\text{F at }1~\text{kHz}\\ & R>50~\%~\text{of initial specified value} \end{split}$		
8	Operational life	MIL-STD 202 method 108	T _{amb} = 110 °C; (310 V _{AC}) 250 h / 500 h / 1000 h	$\begin{split} & \Delta C/C \leq 10~\%\\ & \text{Increase of tan }\delta\\ &\leq 0.008~\text{for }C \leq 1~\mu\text{F at }10~\text{kHz or}\\ &\leq 0.005~\text{for }C > 1~\mu\text{F at }1~\text{kHz}\\ & R>50~\%~\text{of initial specified value} \end{split}$		
9	External visual	MIL-STD 883 method 2009	Device construction, marking, and workmanship	Device construction and workmanship; legible marking		
10	Physical dimension	JESD22 method JB-100	Spec.	Datasheet		
11	Terminal strength (leaded)	MIL-STD 202 method 211	Test leaded device lead integrity only A (pull-test): 2.27 kg (10 s) - C (wire-lead bend test): 227 g (3 x 3 s)	No visual damage		
12	Resistance to solvents	MIL-STD 202 method 215	 Also aqueous chemical OKEM clean or equivalent. Do not use banned solvents. 	No visual damage Legible marking		
13	Mechanical shock	MIL-STD 202 method 213	100 <i>g</i> 's; 6 ms half-sine; 3.75 m/s	No visual damage		
14	Vibration	MIL-STD 202 method 204	5 g's for 20 min; 12 cycles x 3 directions 10 Hz to 2000 Hz	No visual damage		
15	Resistance to soldering heat	MIL-STD 202 method 210	280 °C; 10 s solder within 1.5 mm of device body	$\begin{split} & \Delta C/C \leq 5~\%\\ & \text{Increase of tan }\delta\\ &\leq 0.008~\text{for }C \leq 1~\mu\text{F at }10~\text{kHz or}\\ &\leq 0.005~\text{for }C > 1~\mu\text{F at }1~\text{kHz}\\ & R>50~\%~\text{of initial specified value} \end{split}$		
17	ESD	-	-	-		
18	Solderability	J-STD-002	Leaded: method A, category 3 (245 °C / 3 s)	Good tinning as evidence by free flowing of the solder with wetting of terminations > 95 %		
19	Electrical characterization	-	-	-		
20	Flammability	UL 94 IEC 60384-1	One flame application Class B	V-0 or V-1 are acceptable. Class B or C acc. IEC is also acceptable		



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